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RoHS'

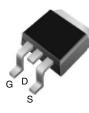
COMPLIANT

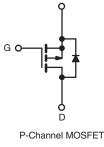
HALOGEN

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 100				
R _{DS(on)} (Ω)	$V_{GS} = -10 V$	0.60			
Q _g (Max.) (nC)	18				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	9.0				
Configuration	Single				

D²PAK (TO-263)





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FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION							
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)				
Lead (Pb)-free and Halogen-free	SiHF9520S-GE3	SiHF9520STRL-GE3 ^a	SiHF9520STRR-GE3 ^a				
Lood (Bb) free	IRF9520SPbF	IRF9520STRLPbF ^a	IRF9520STRRPbF ^a				
Lead (Pb)-free	SiHF9520S-E3	SiHF9520STL-E3ª	SiHF9520STR-E3 ^a				

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	- 100	Ň			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current	V_{GS} at - 10 V $T_{C} = 25 \degree C$ $T_{C} = 100 \degree C$			- 6.8		
Continuous Drain Current	V _{GS} at - 10 V	T _C = 100 °C	l _D	- 4.8	А	
Pulsed Drain Current ^a			I _{DM}	- 27		
Linear Derating Factor				0.40	W/°C	
Linear Derating Factor (PCB Mount) ^e		0.025	W/ C			
Single Pulse Avalanche Energy ^b		E _{AS}	300	mJ		
Avalanche Current ^a			I _{AR}	- 6.8	А	
Repetiitive Avalanche Energy ^a			E _{AR}	6.0	mJ	
Maximum Power Dissipation	25 °C	D	60	w		
Maximum Power Dissipation (PCB Mount) ^e	T _A =	25 °C	PD	3.7	v	
Peak Diode Recovery dV/dt ^c		dV/dt	- 5.5	V/ns		
Operating Junction and Storage Temperature Rang	e		T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for	10 s	<u> </u>	300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = - 25 V, starting T_J = 25 °C, L = 9.7 mH, R_g = 25 Ω , I_{AS} = - 6.8 A (see fig. 12).

c. I_{SD} ≤ - 6.8 A, dl/dt ≤ 110 A/µs, V_{DD} ≤ V_{DS} , T_{J} ≤ 175 °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62				
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	40	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5				

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS			TYP.	MAX.	UNIT
Static		·					•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0, I _D = - 250 μA	- 100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.1	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$		- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zene Oete Veltere Durin Ormert	I _{DSS}	V _{DS} =	- 100 V, V _{GS} = 0 V	-	-	- 100	μA
Zero Gate Voltage Drain Current		V _{DS} = - 80 V	/, V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 4.1 A ^b	_	-	0.60	Ω
Forward Transconductance	9 _{fs}	V _{DS} = -	- 50 V, I _D = - 4.1 A ^b	2.0	-	-	S
Dynamic						•	
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	390	-	
Output Capacitance	C _{oss}		$V_{DS} = -25 V,$	-	170	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	_	45	-	
Total Gate Charge	Qg			_	-	18	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$I_D = -6.8 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 ^b	_	-	3.0	
Gate-Drain Charge	Q _{gd}		see ng. o and ro	-	-	9.0	
Turn-On Delay Time	t _{d(on)}			-	9.6	-	- ns
Rise Time	t _r		- 50 V, I _D = - 6.8 A,	-	29	-	
Turn-Off Delay Time	t _{d(off)}		$R_D = 7.1 \Omega$, see fig. 10^{b}	_	21	-	
Fall Time	t _f	1		-	25	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") 1	, 	-	4.5	-	nH
Internal Source Inductance	Ls	package and die contact	package and center of		7.5	-	1111
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	- 6.8	А
Pulsed Diode Forward Current ^a	I _{SM}				-	- 27	
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_{\rm S}$ = - 6.8 A, $V_{\rm GS}$ = 0 $V^{\rm b}$	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 25 °C	= - 6.8 A, dl/dt = 100 A/µs ^b	-	98	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$J = 23 \text{ C}, I_{\text{F}} =$	$= -0.0 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{S}^{2}$	-	0.33	0.66	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	v Ls and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

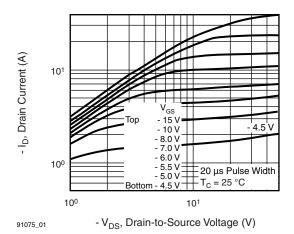


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

Тор

5. Bottom

10¹

100

100

- I_D, Drain Current (A)

91075_02

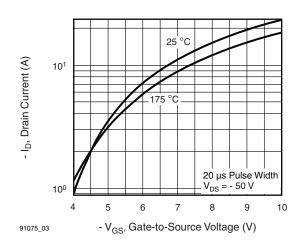


Fig. 3 - Typical Transfer Characteristics

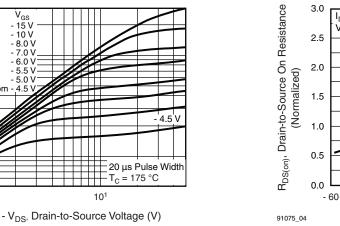


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

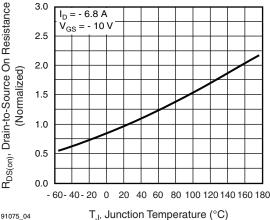


Fig. 4 - Normalized On-Resistance vs. Temperature

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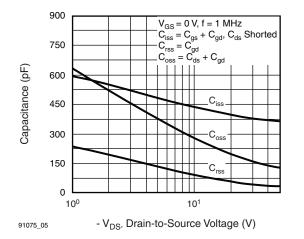


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

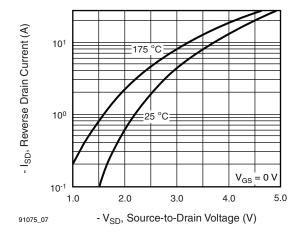


Fig. 7 - Typical Source-Drain Diode Forward Voltage

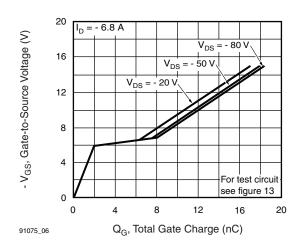


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

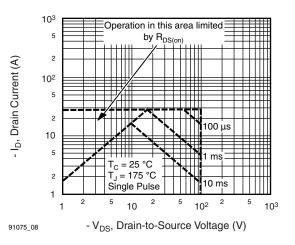


Fig. 8 - Maximum Safe Operating Area

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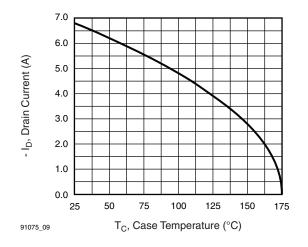


Fig. 9 - Maximum Drain Current vs. Case Temperature

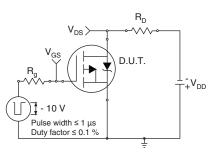


Fig. 10a - Switching Time Test Circuit

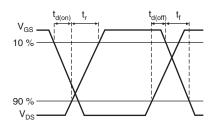


Fig. 10b - Switching Time Waveforms

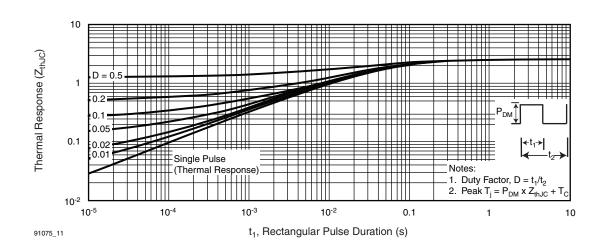


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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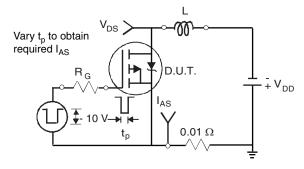


Fig. 12a - Unclamped Inductive Test Circuit

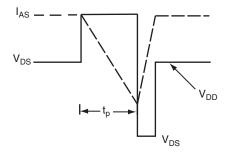


Fig. 12b - Unclamped Inductive Waveforms

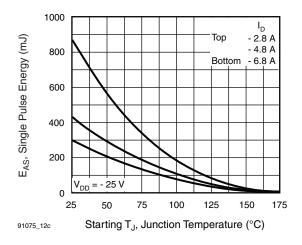
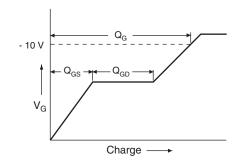
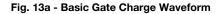


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





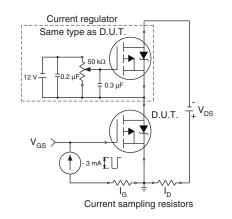
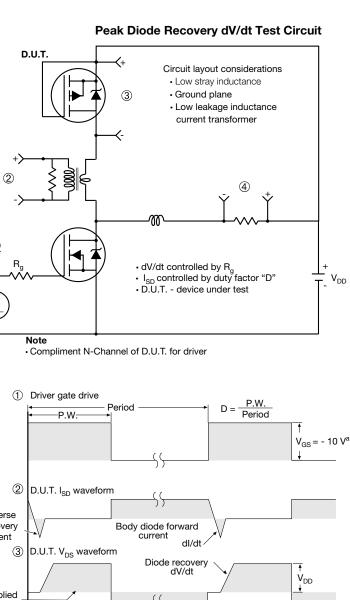


Fig. 13b - Gate Charge Test Circuit

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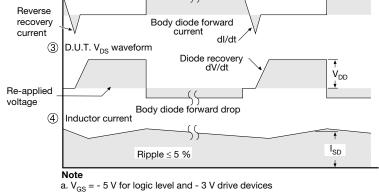


Fig. 14 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91075</u>.

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INCHES				MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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